TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIV) ataSheet4U.com

# **TPCP8302**

Lithium Ion Battery Applications Notebook PC Applications Portable Equipment Applications

· Small footprint due to small and thin package

• Low drain-source ON-resistance:  $R_{DS(ON)} = 25 \text{ m}\Omega$  (typ.)

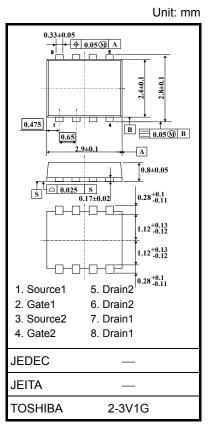
• High forward transfer admittance: |Y<sub>fs</sub>| = 14 S (typ.)

• Low leakage current:  $I_{DSS} = -10 \mu A \text{ (max)} (V_{DS} = -20 \text{ V})$ 

• Enhancement mode:  $V_{th} = -0.4$  to -1.0 V ( $V_{DS} = -6$  V,  $I_D = -1$  mA)

#### Absolute Maximum Ratings (Ta = 25°C)

Cha	racteristic	Symbol	Rating	Unit	
Drain-source voltage	ge	V <sub>DSS</sub> –20			
Drain-gate voltage	(R <sub>GS</sub> = 20 kΩ)	$V_{DGR}$	-20	V	
Gate-source voltage	e	$V_{GSS}$	±12	٧	
Drain current	DC (Note 1)	ΙD	-5	۸	
Diam current	Pulse (Note 1)	I <sub>DP</sub>	-20	Α	
Drain power dissipation	Single-device operation (Note 3a)	P <sub>D (1)</sub>	1.48		
(t = 5 s) (Note 2a)	Single-device value at dual operation (Note 3b)	P <sub>D (2)</sub>	-5 -20 1.48 1.23 0.58 0.36 6.5 -5	10/	
Drain power dissipation	Single-device operation (Note 3a)	P <sub>D (1)</sub>	0.58	VV	
(t = 5 s) (Note 2b)	Single-device value at dual operation (Note 3b)	P <sub>D (2)</sub>	1.48 1.23 0.58 0.36 6.5 m.		
Single-pulse avala	nche energy (Note 4)	E <sub>AS</sub>	6.5	mJ	
Avalanche current		I <sub>AR</sub>	-5	Α	
Repetitive avalance Single-device value		E <sub>AR</sub>	E <sub>AR</sub> 0.12		
Channel temperatu	ire	T <sub>ch</sub>	150 °C		
Storage temperatu	re range	T <sub>stg</sub>	-55 to 150	°C	



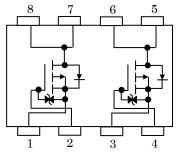
Weight: 0.017 g (typ.)

Note: For Notes 1 to 6, see the next page.

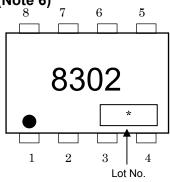
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

## **Circuit Configuration**



### Marking (Note 6)





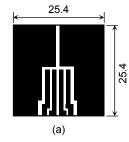
#### **Thermal Characteristics**

Characteristic		Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	Single-device operation (Note 3a)	R <sub>th (ch-a) (1)</sub>	84.5	°C/W	
	Single-device value at dual operation (Note 3b)	R <sub>th (ch-a) (2)</sub>	101.6		
Thermal resistance, channel to ambient	Single-device operation (Note 3a)	R <sub>th (ch-a) (1)</sub>	215.5	°C/W	
(t = 5 s) (Note 2b)	Single-device value at dual operation (Note 3b)	R <sub>th (ch-a) (2)</sub>	347.2	5/ \$	

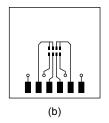
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)

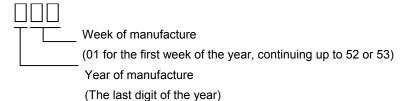


FR-4 25.4 × 25.4 × 0.8 (Unit: mm)



FR-4  $25.4\times25.4\times0.8$  (Unit: mm)

- Note 3: a) The power dissipation and thermal resistance values shown are for a single device. (During single-device operation, power is applied to one device only.)
  - b) The power dissipation and thermal resistance values shown are for a single device. (During dual operation, power is applied to both devices evenly.).
- Note 4:  $V_{DD} = -16 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 0.2 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = -5 \text{ A}$
- Note 5: Repetitive rating: pulse width limited by maximum channel temperature
- Note 6: on the lower left of the marking indicates Pin 1.
  - \* Weekly code (three digits):





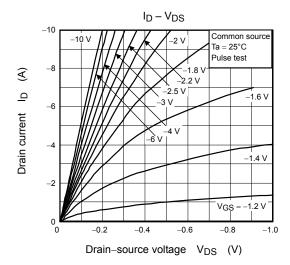
# Electrical Characteristics (Ta = 25°C)

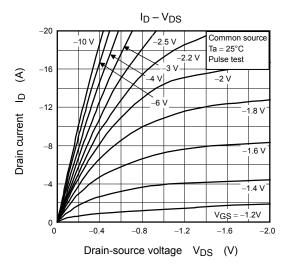
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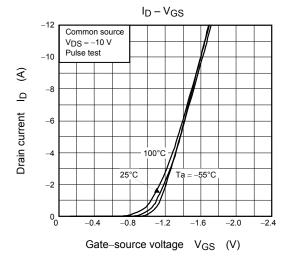
Ch	aracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I <sub>GSS</sub>	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cutoff curre	ent	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μА
Drain-source bre	akdown voltage	V <sub>(BR) DSS</sub>	$I_D = -10$ mA, $V_{GS} = 0$ V	—     —     —10       -20     —     —       -8     —     —       -0.4     —     —1.0       —     50     95       —     33     45       —     25     33       7     14     —       —     1500     —       —     220     —       —     240     —	V		
Diam-30urce bre	andown voltage	V <sub>(BR) DSX</sub>	$I_D = -10$ mA, $V_{GS} = 12$ V	-8	_	_	V
Gate threshold ve	oltage	V <sub>th</sub>	$V_{DS} = -6 \text{ V}, I_D = -1 \text{ mA}$	-0.4	_	-1.0	V
		R <sub>DS</sub> (ON)	$V_{GS} = -1.8 \text{ V}, I_D = -0.3 \text{ A}$	_	50	95	
Drain-source ON-resistance  Forward transfer admittance		R <sub>DS</sub> (ON)	$V_{GS} = -2.5 \text{ V}, I_D = -2.5 \text{A}$	_	33	45	mΩ
		R <sub>DS</sub> (ON)	$V_{GS} = -4 \text{ V}, I_D = -2.5 \text{A}$	-4 V, I <sub>D</sub> = -2.5A		33	
Forward transfer	Forward transfer admittance $ Y_{fS} $ $V_{DS} = -10 \text{ V}, I_D = -2.5 \text{ A}$		$V_{DS} = -10 \text{ V}, I_D = -2.5 \text{A}$	7	14	_	S
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	1500	_	pF
Reverse transfer capacitance		C <sub>rss</sub>		_	220	_	
Output capacitance		Coss		_	240	_	
	Rise time	t <sub>r</sub>	V <sub>GS</sub> -5V   I <sub>D</sub> = -2.5A   OUT   OUT	_	10	_	
	Turn-on time	t <sub>on</sub>		_	20	_	
	Fall time	t <sub>f</sub>		_	65	_	ns
	Turn-off time	t <sub>off</sub>	$V_{DD} \approx -10 \text{ V}$ Duty $\leq$ 1%, $t_W = 10 \mu\text{s}$	_	200	_	
Total gate charge (gate-source plus		$Q_g$ $V_{DD} \approx -16 \text{ V}, V_{GS} = -5 \text{ V},$ $Q_{DD} = -20 $		_	_		
Gate-source charge1		Q <sub>gs1</sub>	$I_D = -5 \text{ A}$	_	3.6	_	nC
Gate-drain ("Mille	er") charge	Q <sub>gd</sub>	]	_	5.1	_	

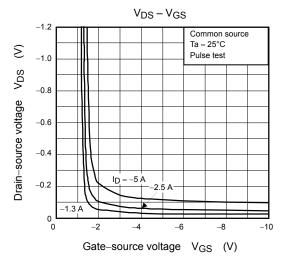
# **Source-Drain Ratings and Characteristics (Ta = 25°C)**

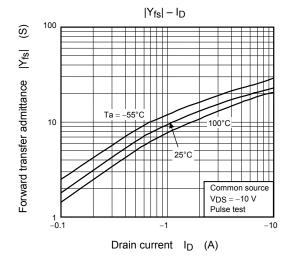
Characteristic Syn		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I <sub>DRP</sub>	_	_	_	-20	Α
Forward voltage (diode)		$V_{DSF}$	$I_{DR} = -5 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

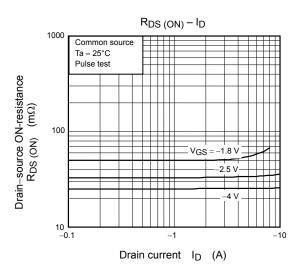


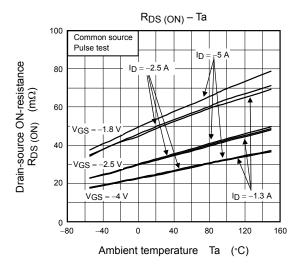


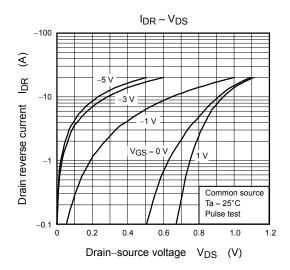


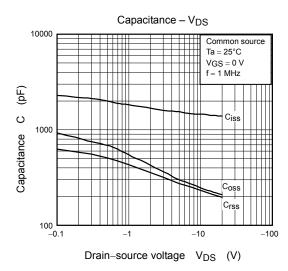


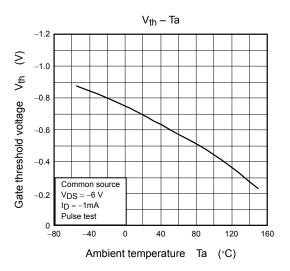


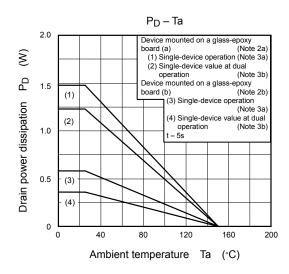


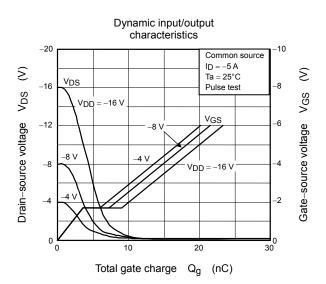


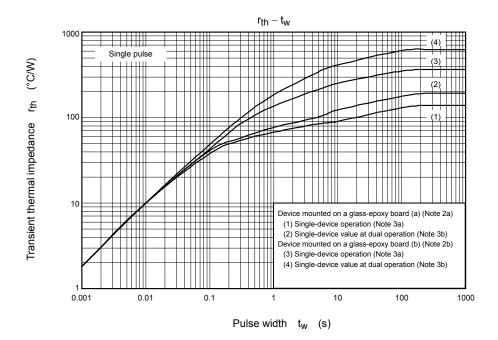




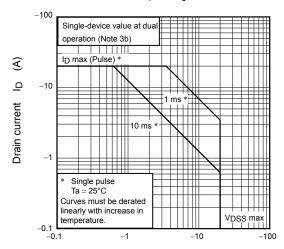








#### Safe operating area



TOSHIBA TPCP8302

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